



APPLICATIONS

- Battery-powered devices
- Portable devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 13.5mmx12.6mmx6.2mm
- Molded Construction
- Low Audible Noise
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

Parameter			Value	Unit
Inductance ⁽¹⁾	L	±20%	8.2	μH
Resistance	R_{DC}	typ	12.5	mΩ
Resistance _{MAX}	$R_{DC\ MAX}$	max	13.9	mΩ
Rated Current ⁽²⁾	I_R	typ	11.5	A
Saturation Current _{25°C} ⁽³⁾	$I_{SAT\ 25°C}$	typ	18	A
Saturation Current _{100°C} ⁽⁴⁾	$I_{SAT\ 100°C}$	typ	18	A
Resonance Frequency	f_r	typ	8	MHz

GENERAL SPECIFICATIONS

⁽¹⁾ Inductance Measured at 100kHz, 100mA

⁽²⁾ Rated Current

Rated current will cause the coil temperature rise ΔT of 40K
 I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.

⁽³⁾ Saturation Current _{25°C}

Saturation current will cause L to drop from 30% at 25°C ambient temperature

⁽⁴⁾ Saturation Current _{100°C}

Saturation current will cause L to drop from 30% at 100°C ambient temperature

Temperature Test Condition

Electrical specifications measured at 25°C, 35% RH if not given differently

Operating Condition

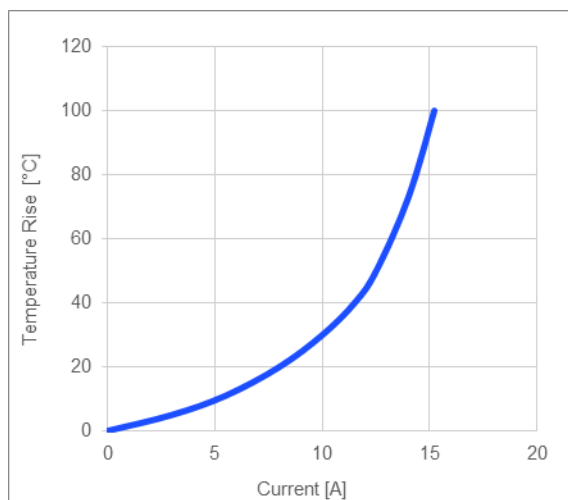
Operating temperature: -40°C to +155°C (including temp rise)
 Should not exceed +155°C under worst-case operation conditions

Storage Condition

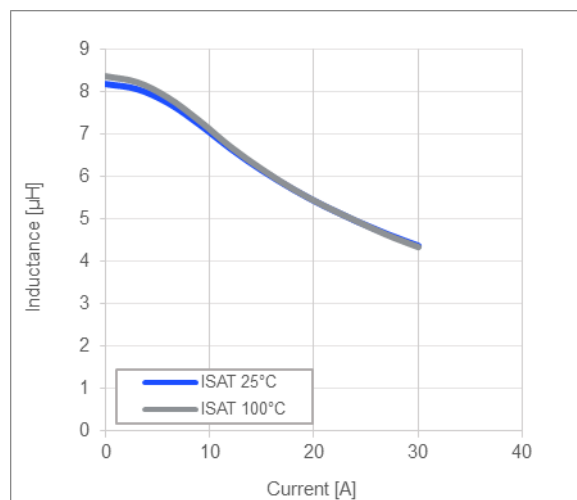
Tape and Reel packaging: -10°C to +40°C
 Humidity: <50% RH

TYPICAL PERFORMANCE CURVES

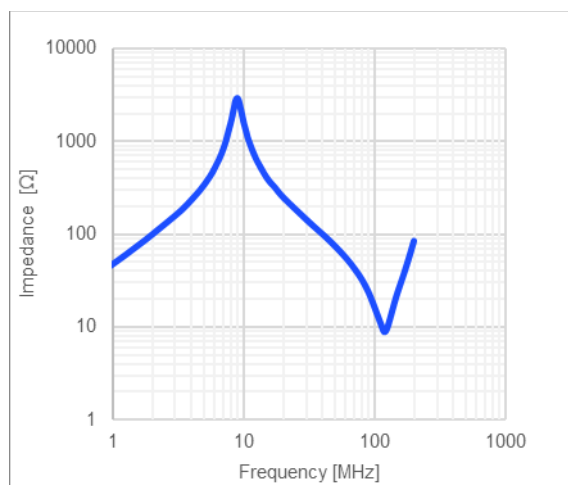
Temperature Rise vs. Current



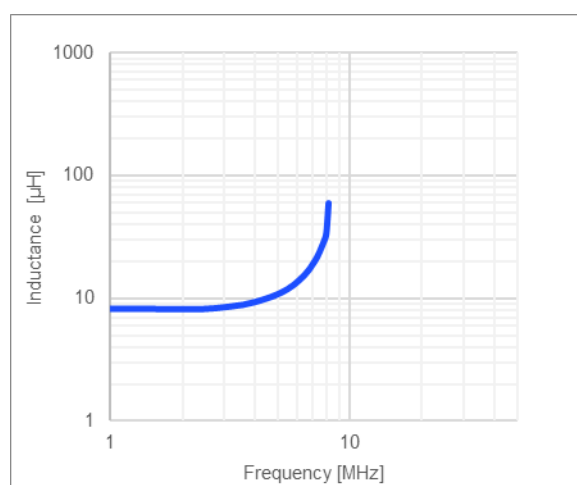
Inductance vs. Current



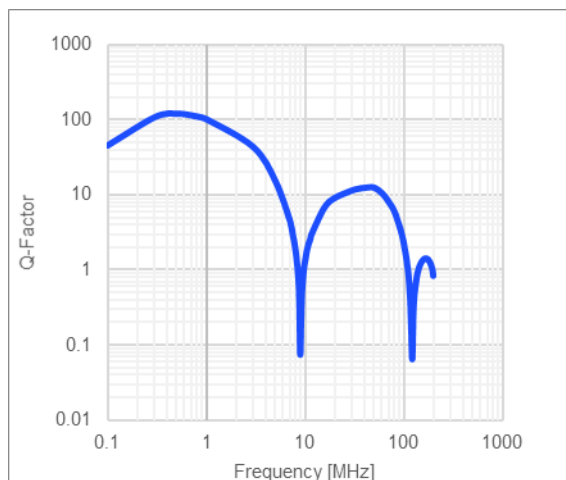
Impedance vs. Frequency



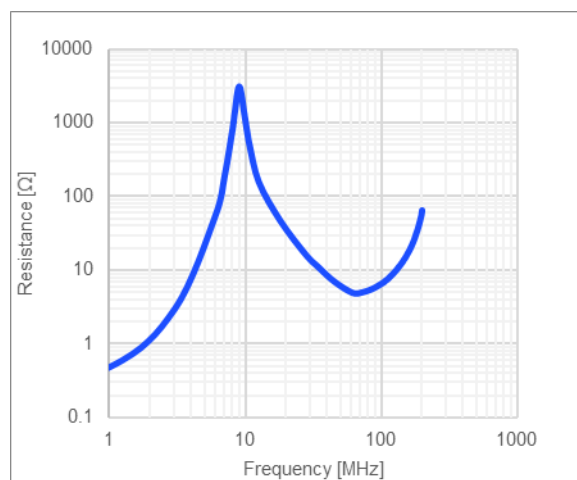
Inductance vs. Frequency



Quality Factor vs. Frequency



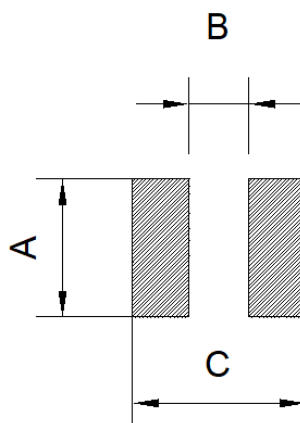
AC Resistance vs. Frequency



LAND PATTERN

Dimensions

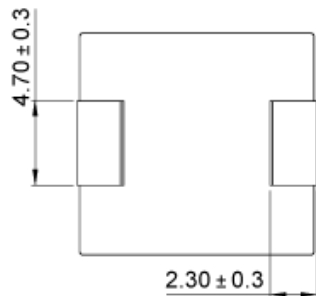
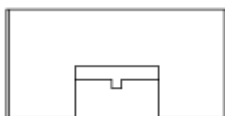
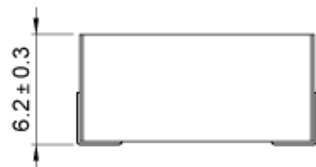
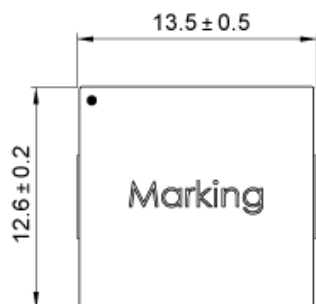
A	5.0 ref.
B	8.0 ref.
C	14.50 ref. (unit in mm)



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING

Marking

Start of Winding	· (dot)
Inductance Code	8R2
MPS Code	MPS
Date Code	YYWW

ORDERING INFORMATION

Part Number	$L^{(1)}$ typ (μH)	R_{DC} typ (mΩ)	$I_R^{(2)}$ typ (A)	$I_{SAT\ 25^{\circ}C}^{(3)}$ typ (A)	$I_{SAT\ 100^{\circ}C}^{(4)}$ typ (A)
MPL-AY1265-R47	0.47	0.89	33	64	64
MPL-AY1265-R56	0.56	1.1	31	58	58
MPL-AY1265-R68	0.68	1.25	29	51	51
MPL-AY1265-R82	0.82	1.3	27	46	46
MPL-AY1265-1R0	1.0	1.5	25.5	43	43
MPL-AY1265-1R2	1.2	1.8	24	37	37
MPL-AY1265-1R5	1.5	2.3	22	34	34
MPL-AY1265-1R8	1.8	3.3	20	29	29
MPL-AY1265-2R2	2.2	3.7	17	26.5	26.5
MPL-AY1265-3R3	3.3	5.5	16	25	25
MPL-AY1265-4R7	4.7	7.0	14	23	23
MPL-AY1265-5R6	5.6	8.6	13	20	20
MPL-AY1265-6R8	6.8	9.9	12	19.5	19.5
MPL-AY1265-8R2	8.2	12.5	11.5	18	18
MPL-AY1265-100	10	13.3	10.7	16	16
MPL-AY1265-150	15	21.8	8.5	12	12
MPL-AY1265-220	22	31.4	7	9	9

GENERAL SPECIFICATIONS

(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K <i>I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.</i>
(3) Saturation Current $_{25^{\circ}C}$	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current $_{100^{\circ}C}$	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise) Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

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